## **Application Data Sheet**

#### **Application Information**

Application Type:: Regular

Subject Matter:: Utility

Suggested Classification::

Suggested Group Art Unit::

CD-ROM or CD\_R?:: None

Number of CD disks::

Number of copies of CDs::

Sequence Submission:: No

Computer Readable Form (CRF)?:: No

Title:: SEMICONDUCTOR CHIP MODULE

Attorney Docket Number:: 08688.0128USD1

Request For Early Publication:: No

Request For Non-Publication:: No

Suggested Drawing Figure::

Total Drawing Sheets::

Small Entity:: No

Latin Name::

Variety Denomination Name::

Petition Included:: No

Petition Type::

Licensed US Govt. Agency::

Contract or Grant Numbers::

Secrecy Order in Parent Appl.?:: No

#### **Applicant Information**

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Taiwan

Status::

**Full Capacity** 

Given Name::

Ming-Tung

Middle Name::

Family Name::

SHEN

Name Suffix::

City of Residence::

**Taipei City** 

State or Province of Residence::

Country of Residence::

Taiwan

Street of mailing address::

4F, No. 52, Sec. 2, Chung-Shan N. Rd.

City of mailing address::

Taipei City

State or Province of mailing address::

Country of mailing address::

Taiwan

Postal or Zip Code of mailing address::

### Correspondence Information

Correspondence Customer Number::

23552

### Representative Information

Representative Customer Number::	23552	

### **Domestic Priority Information**

Application::	Continuation Type::	Parent Application::	Parent Filing Date::
This Application	Division of	09/407,204	09/28/99

# Foreign Priority Information

Country::	Application Number::	Filing Date::	Priority Claimed::
Taiwan	88212813	07/30/99	Yes